

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: LEE, Joong-Hee; YOO, Gye-Hyoung

SERIAL NO.: 10/598496 (International Serial No. PCT/KR2004/002319)

FILED: August 31, 2006 (International Filing Date: 10 September 2004)

TITLE: HIGH GAS-TIGHTENED METALLIC NOZZLE-BOSS FOR A HIGH PRESSURE
COMPOSITE VESSEL

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

1. Attached is a copy of the Official Filing Receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.

NOTE: The PTO will not correct the filing receipt until the application is complete (in other words, the applicant files a response to the notice to file missing parts).

2. There is an error with respect to the following data, which is:

☒ incorrectly entered

AND/OR

☐ omitted.

3. The error is in:

Correct data:

1. ☒ Applicant's name
2. ☐ Applicant's address
3. ☐ Title
4. ☐ Filing date
5. ☐ Application number
6. ☐ Foreign/PCT Application Re:
7. ☐ Other

1. LEE, Joong-Hee; YOO, Gye-Hyoung
- 2.
- 3.
- 4.
- 5.
- 6.
7. (none)

4. Explanation (if necessary)

"Young-Jun KWON" is NOT an inventor/applicant. Please remove his name. An updated copy of the Application Data Sheet is filed concurrent herewith.

The proper inventor, Joong-Hee LEE has signed the Declaration or Oath of inventorship, and he was properly listed in the Application Data Sheet.

Respectfully submitted,

<u>June 21, 2007</u>	<u>/Andrew W. Chu/</u>
Date	John S. Egbert Reg. No. 30,627 Andrew W. Chu Reg. No. 46,625 Attorney for Applicant
Customer No. 24106	Egbert Law Offices 412 Main Street, 7 th Floor Houston, Texas 77002 (713)224-8080 (713)223-4873 (Fax)

CERTIFICATE OF MAILING UNDER 37 CFR 1.8(a)

I hereby certify that the attached REQUEST FOR CORRECTED FILING RECEIPT is being e-filed or first-class mailed to:

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

on June 21, 2007.

<u>June 21, 2007</u>	<u>/Andrew W. Chu/</u>
Date	John S. Egbert/Andrew W. Chu